

## DESCRIPTION

The MP1924 is a high-frequency, 100V, half-bridge, N-channel, power MOSFET driver. Its low-side and high-side driver channels are independently controlled and matched with less than 5ns in time delay. Under-voltage lockout on both high-side and low-side supplies force their outputs low in case of insufficient supply. The integrated bootstrap diode reduces external component count.

## FEATURES

- Drives an N-Channel MOSFET Half Bridge
- 118V  $V_{BST}$  Voltage Range
- On-Chip Bootstrap Diode
- Typical Propagation Delay of 20ns
- Gate Drive Matching of Less than 5ns
- Drives a 2.2nF Load with 15ns Rise Time and 12ns Fall Time at 12V VDD
- TTL-Compatible Input
- Quiescent Current of Less than 150 $\mu$ A
- UVLO for Both High Side and Low Side
- QFN-10 (4mmx4mm) and SOIC-8 Packages

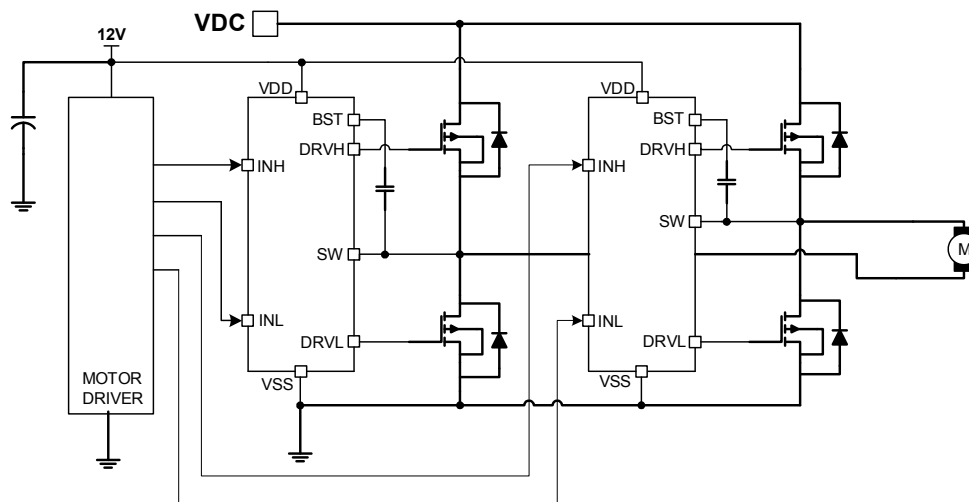
## APPLICATIONS

- Motor Drivers
- Telecom Half-Bridge Power Supplies
- Avionics DC-DC Converters
- Two-Switch Forward Converters
- Active-Clamp Forward Converters

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## TYPICAL APPLICATION



**ORDERING INFORMATION**

<b>Part Number</b>	<b>Package</b>	<b>Top Marking</b>
MP1924HR*	QFN-10 (4x4mm)	<i>See Below</i>
MP1924HS**	SOIC-8	<i>See Below</i>

\* For Tape & Reel, add suffix -Z (e.g. MP1924HR-Z)  
For RoHS compliant packaging, add suffix -LF (e.g. MP1924HR-LF-Z)  
\*\* For Tape & Reel, add suffix -Z (e.g. MP1924HS-Z)  
For RoHS compliant packaging, add suffix -LF (e.g. MP1924HS-LF-Z)

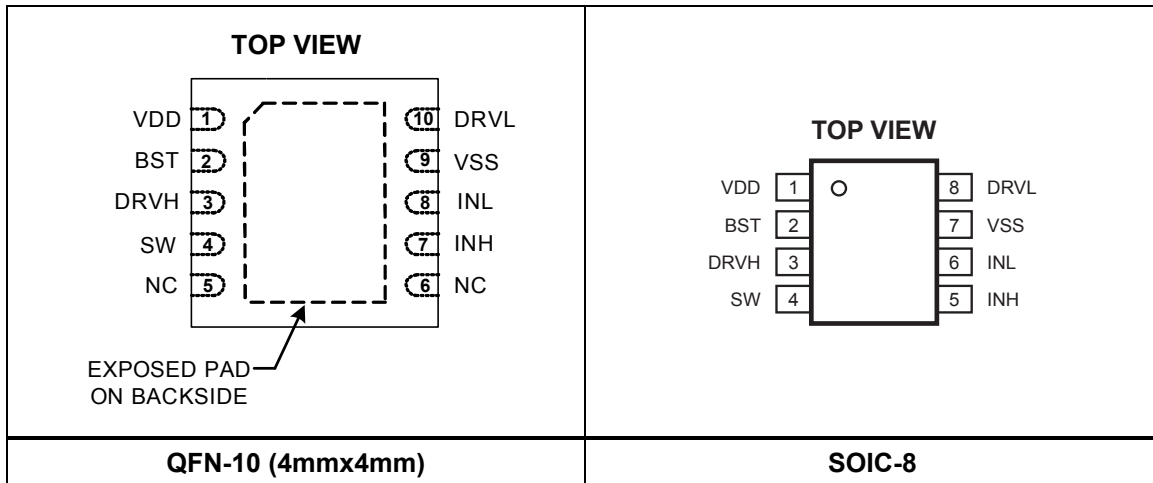
**TOP MARKING (MP1924HR)****MPSYWW****MP1924****LLLLLL**

MPS: MPS prefix;  
Y: year code;  
WW: week code;  
MP1924: product code of MP1924HR;  
LLLLLL: lot number;

**TOP MARKING (MP1924HS)****MP1924****LLLLLLLLL****MPSYWW**

MP1924: product code of MP1924HS;  
LLLLLLLLL: lot number;  
MPS: MPS prefix;  
Y: year code;  
WW: week code;

## PACKAGE REFERENCE



### Absolute Maximum Ratings <sup>(1)</sup>

Supply Voltage ( $V_{DD}$ ).....	-0.3V to 18V
SW Voltage ( $V_{SW}$ ) .....	-5.0V to 105V
BST Voltage ( $V_{BST}$ ) .....	-0.3V to 118V
BST to SW .....	-0.3V to 18V
DRVH to SW .....	-0.3V to (BST-SW) + 0.3V
DRVL to VSS .....	-0.3V to ( $V_{DD} + 0.3V$ )
All Other Pins.....	-0.3V to ( $V_{DD} + 0.3V$ )
Continuous Power Dissipation ( $T_A = 25^\circ\text{C}$ ) <sup>(2)</sup>	
QFN-10 (4mmx4mm).....	2.66W
SOIC-8 .....	1.3W
Junction Temperature .....	150°C
Lead Temperature .....	260°C
Storage Temperature.....	-65°C to 150°C

### Recommended Operating Conditions <sup>(3)</sup>

Supply Voltage $V_{DD}$ .....	9.0V to 16.0V
SW Voltage ( $V_{SW}$ ) .....	-1.0V to 100V
SW Slew Rate .....	<50V/ns
Operating Junction Temp. ( $T_J$ ) ...	-40°C to 125°C

<b>Thermal Resistance <sup>(4)</sup></b>	<b><math>\theta_{JA}</math></b>	<b><math>\theta_{JC}</math></b>
QFN-10 (4mmx4mm) .....	47 .....	7.... °C/W
SOIC-8.....	96 .....	45... °C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J(\text{MAX})$ , the junction-to-ambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D(\text{MAX}) = (T_J(\text{MAX}) - T_A) / \theta_{JA}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

## ELECTRICAL CHARACTERISTICS

$V_{DD} = V_{BST} - V_{SW} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ , No load at DRVH and DRVL,  $T_A = +25^\circ C$ , unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units
<b>Supply Currents</b>						
VDD quiescent current	$I_{DDQ}$	INL = INH = 0		100	150	$\mu A$
VDD operating current	$I_{DDO}$	fsw = 500kHz		9		mA
Floating driver quiescent current	$I_{BSTQ}$	INL = INH = 0		60	90	$\mu A$
Floating driver operating current	$I_{BSTO}$	fsw = 500kHz		7.5		mA
Leakage current	$I_{LK}$	BST = SW = 100V		0.05	1	$\mu A$
<b>Inputs</b>						
INL/INH High				2	2.4	V
INL/INH Low			1	1.4		V
INL/INH internal pull-down resistance	$R_{IN}$			185		k $\Omega$
<b>Under Voltage Protection</b>						
VDD rising threshold	$V_{DDR}$		8.1	8.4	8.8	V
VDD hysteresis	$V_{DDH}$			0.5		V
(BST-SW) rising threshold	$V_{BSTR}$		6.9	7.3	7.7	V
(BST-SW) hysteresis	$V_{BSTH}$			0.55		V
<b>Bootstrap Diode</b>						
Bootstrap diode VF @ 100 $\mu A$	$V_{F1}$			0.5		V
Bootstrap diode VF @ 100mA	$V_{F2}$			0.95		V
Bootstrap diode dynamic R	$R_D$	@ 100mA		2		$\Omega$
<b>Low Side Gate Driver</b>						
Low level output voltage	$V_{OLL}$	$I_O = 100mA$		0.08		V
High level output voltage to rail	$V_{OHL}$	$I_O = -100mA$		0.23		V
Source Current <sup>(5)</sup>	$I_{OHL}$	$V_{DRVL} = 0V, V_{DD} = 12V$		3		A
		$V_{DRVL} = 0V, V_{DD} = 16V$		4.7		A
Sink Current <sup>(5)</sup>	$I_{OLL}$	$V_{DRVL} = V_{DD} = 12V$		4.5		A
		$V_{DRVL} = V_{DD} = 16V$		6		A
<b>Floating Gate Driver</b>						
Low level output voltage	$V_{OLH}$	$I_O = 100mA$		0.08		V
High level output voltage to rail	$V_{OHH}$	$I_O = -100mA$		0.23		V
Source Current <sup>(5)</sup>	$I_{OHH}$	$V_{DRVH} = 0V, V_{DD} = 12V$		2.6		A
		$V_{DRVH} = 0V, V_{DD} = 16V$		4		A
Sink Current <sup>(5)</sup>	$I_{OLH}$	$V_{DRVH} = V_{DD} = 12V$		4.5		A
		$V_{DRVH} = V_{DD} = 16V$		5.9		A

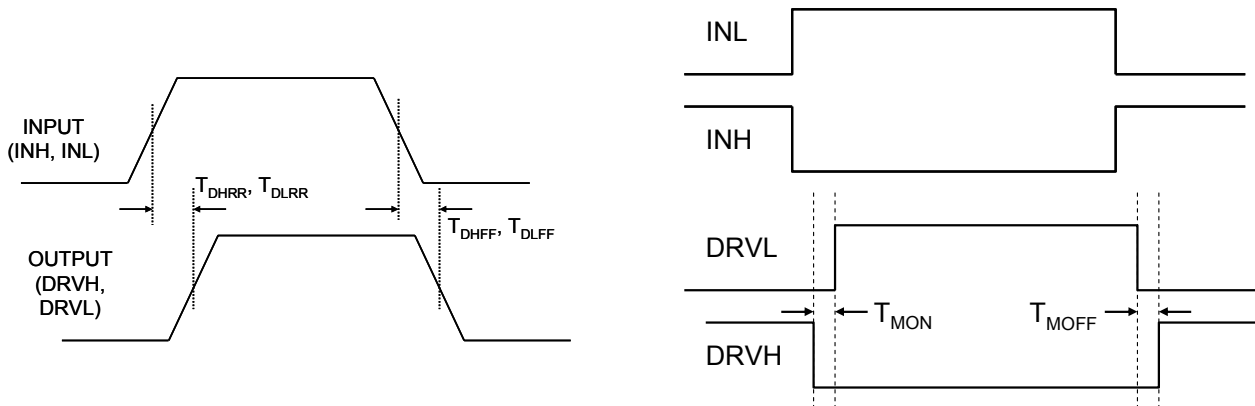
**ELECTRICAL CHARACTERISTICS (continued)**

$V_{DD} = V_{BST} - V_{SW} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ , No load at DRVH and DRVL,  $T_A = +25^\circ C$ , unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units
<b>Switching Spec. --- Low Side Gate Driver</b>						
Turn-off propagation delay INL falling to DRVL falling	$T_{DLFF}$			20		ns
Turn-on propagation delay INL rising to DRVL rising	$T_{DLRR}$			20		
DRVL rise time		$C_L = 2.2nF$		15		ns
DRVL fall time		$C_L = 2.2nF$		9		ns
<b>Switching Spec. --- Floating Gate Driver</b>						
Turn-off propagation delay INH falling to DRVH falling	$T_{DHFF}$			20		ns
Turn-on propagation delay INH rising to DRVH rising	$T_{DHRR}$			20		ns
DRVH rise time		$C_L = 2.2nF$		15		ns
DRVH fall time		$C_L = 2.2nF$		12		ns
<b>Switching Spec. --- Matching</b>						
Floating driver turn-off to low side drive turn-on <sup>(5)</sup>	$T_{MON}$			1	5	ns
Low side driver turn-off to floating driver turn-on <sup>(5)</sup>	$T_{MOFF}$			1	5	ns
Minimum input pulse width that changes the output <sup>(5)</sup>	$T_{PW}$				50	ns
Bootstrap diode turn-on or turn- off time <sup>(5)</sup>	$T_{BS}$			10		ns
Thermal shutdown				150		$^\circ C$
Thermal shutdown hysteresis				25		$^\circ C$

**Note:**

5) Guaranteed by design.

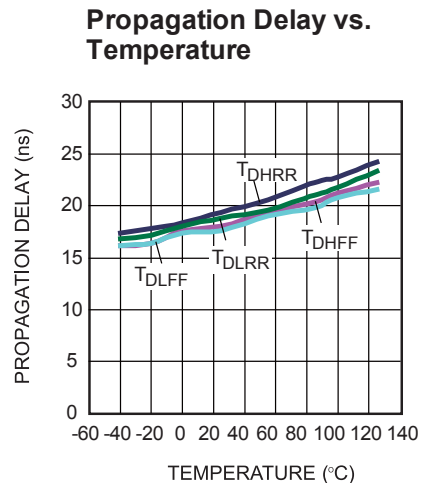
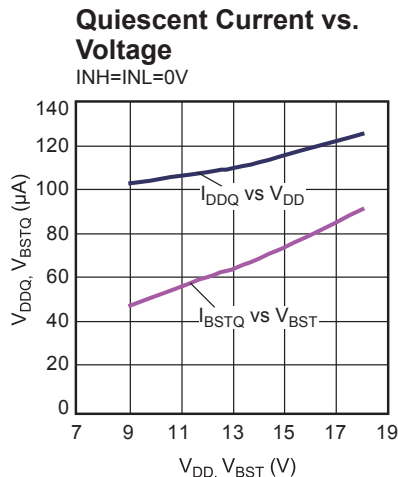
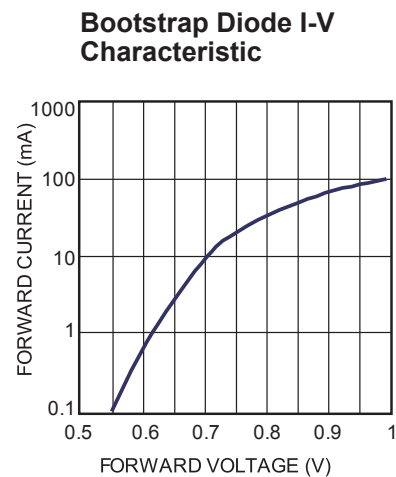
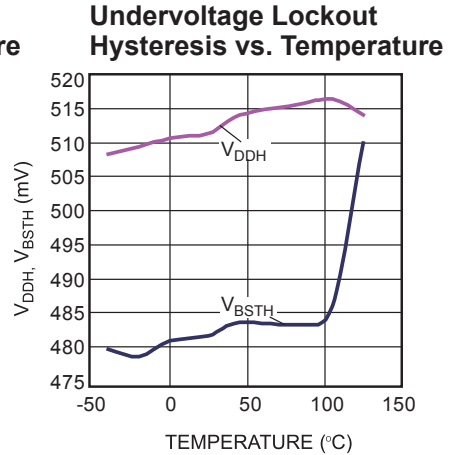
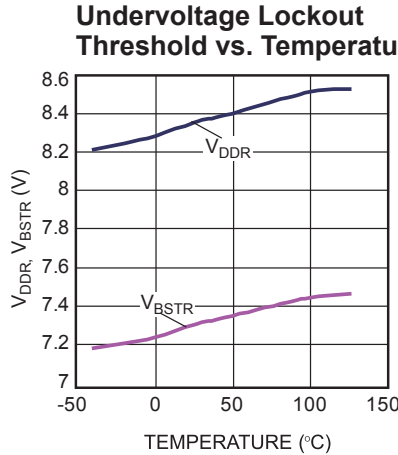
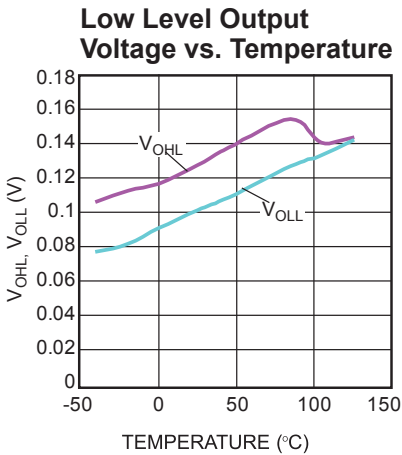
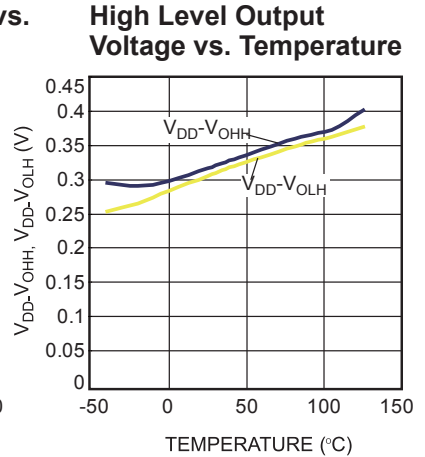
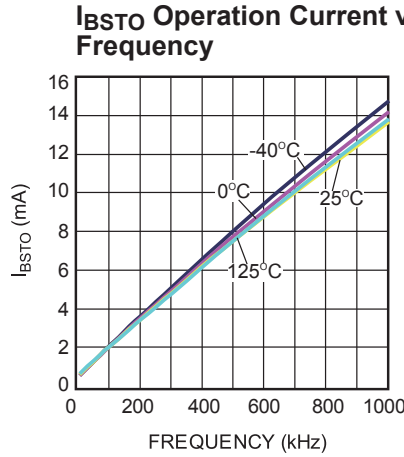
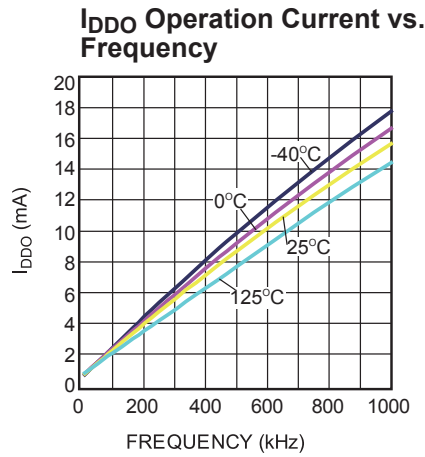

**Figure 1: Timing Diagram**

**PIN FUNCTIONS**

QFN4x4-10 Pin #	SOIC-8 Pin #	Name	Description
1	1	VDD	Supply input. This pin supplies power to all the internal circuitry. Place a decoupling capacitor to ground close to this pin to ensure stable and clean supply.
2	2	BST	Bootstrap. This is the positive power supply for the internal floating high-side MOSFET driver. Connect a bypass capacitor between this pin and SW pin.
3	3	DRVH	Floating driver output.
4	4	SW	Switching node.
5, 6		NC	No connection.
7	5	INH	Control signal input for the floating driver.
8	6	INL	Control signal input for the low side driver.
9	7	VSS, exposed pad	Chip ground. Connect exposed pad to VSS for proper thermal operation.
10	8	DRVL	Low side driver output.

## TYPICAL PERFORMANCE CHARACTERISTICS

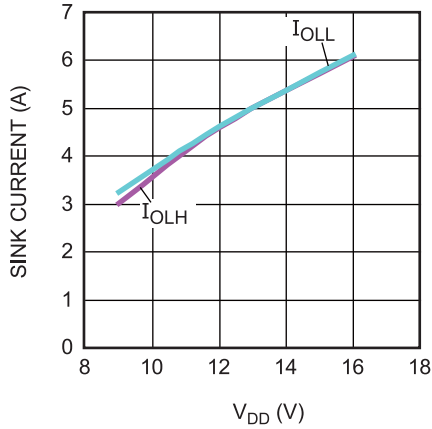
$V_{DD} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.



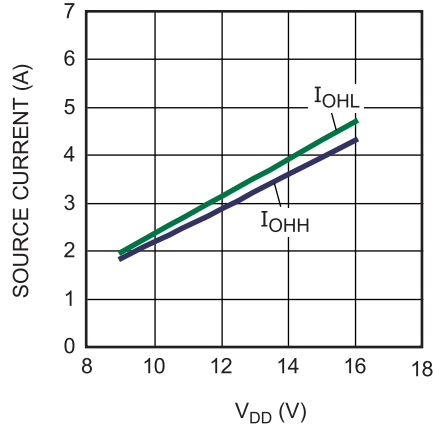
**TYPICAL PERFORMANCE CHARACTERISTICS** *(continued)*

$V_{DD} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.

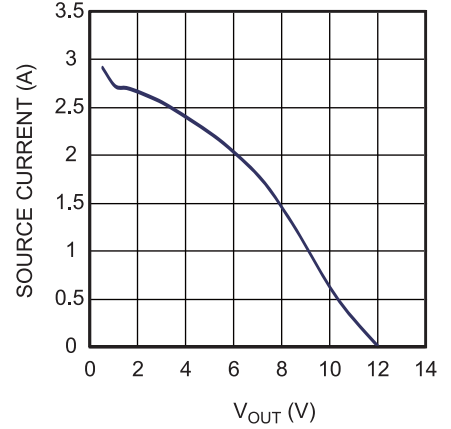
**Sink Current vs.  $V_{DD}$  Voltage**



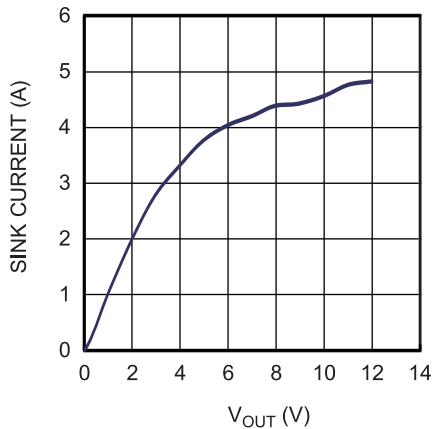
**Source Current vs.  $V_{DD}$  Voltage**



**Source Current vs. Output Voltage**  
 $V_{DD} = 12V$

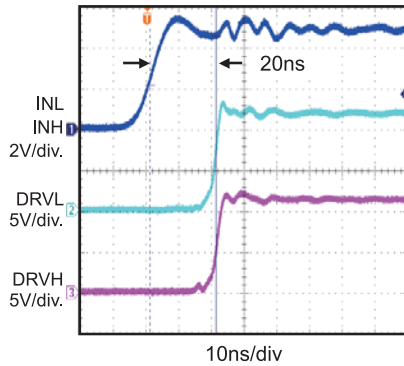
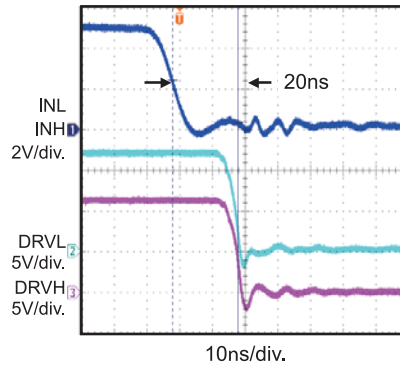
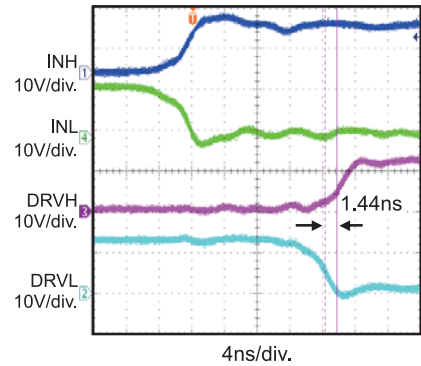
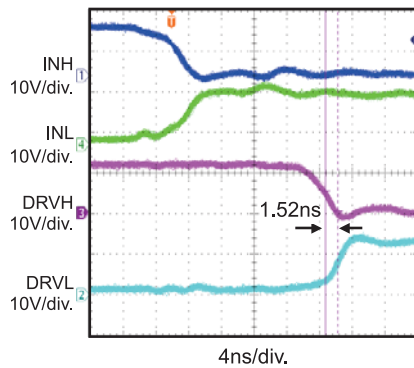


**Sink Current vs. Output Voltage**  
 $V_{DD} = 12V$

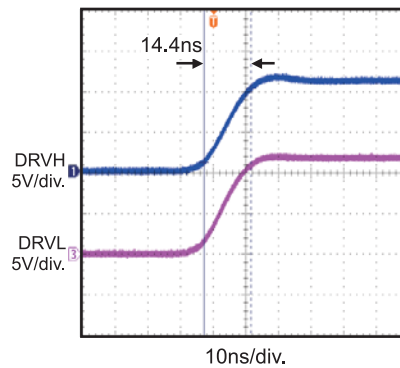




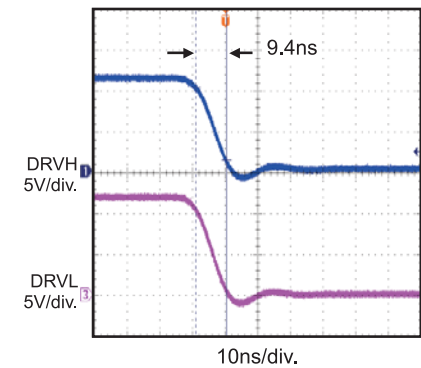
**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**
 $V_{DD} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.

**Turn-on Propagation Delay**

**Turn-off Propagation Delay**

**Gate Drive Matching  $T_{MOFF}$** 

**Gate Drive Matching  $T_{MON}$** 

**Drive Rise Time**

2.2nF Load


**Drive Fall Time**

2.2nF Load



BLOCK DIAGRAM

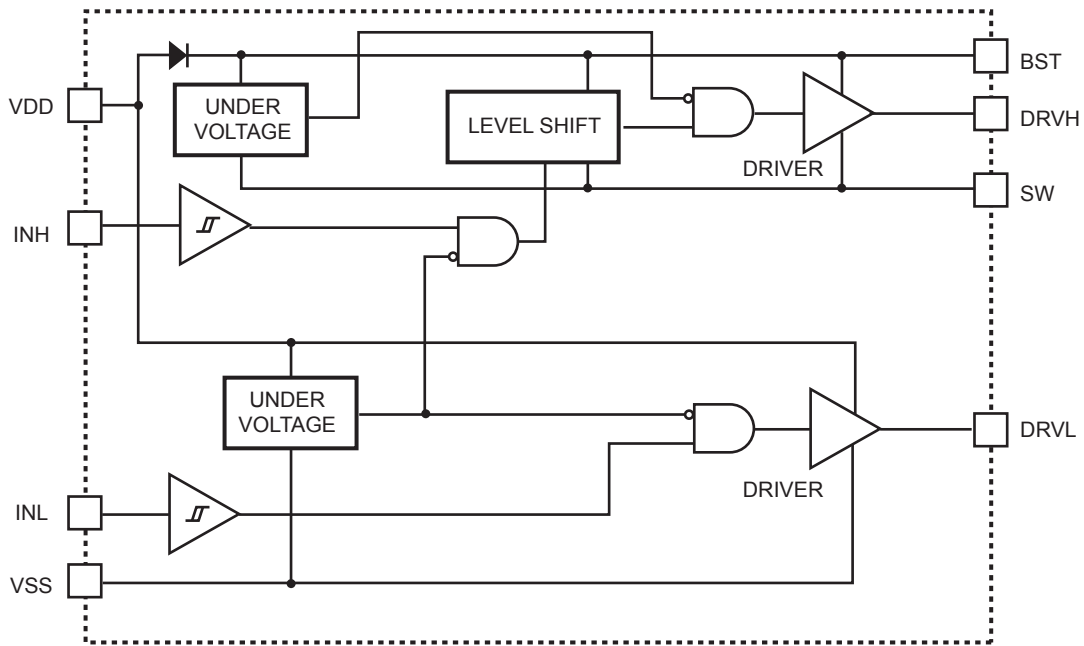
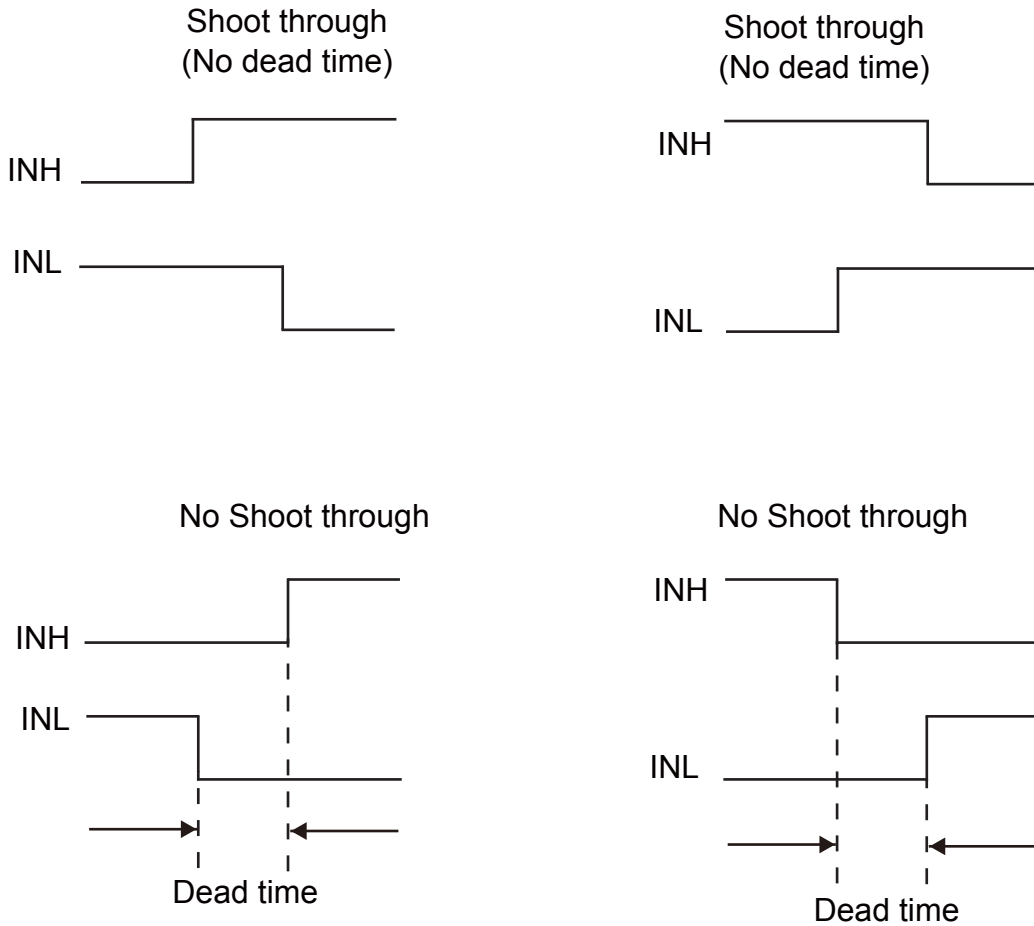


Figure 2: Function Block Diagram

**APPLICATION**

The input signals of INH and INL can be controlled independently. If both INH and INL control the high-side MOSFET and low-side MOSFET of the same bridge, then users must avoid shoot through by

setting sufficient dead time between INH and INL low, and vice versa. See Figure 3 below. Dead time is defined as the time interval between INH low and INL low.



**Figure 3: Shoot-Through Timing Diagram**

## REFERENCE DESIGN CIRCUITS

### Half Bridge Converter

The MP1924 drives the MOSFETs with alternating signals (with dead time) in half-bridge converter topology. Therefore, from the PWM

controller drives INH and INL with alternating signals the input voltage can go up to 100V.

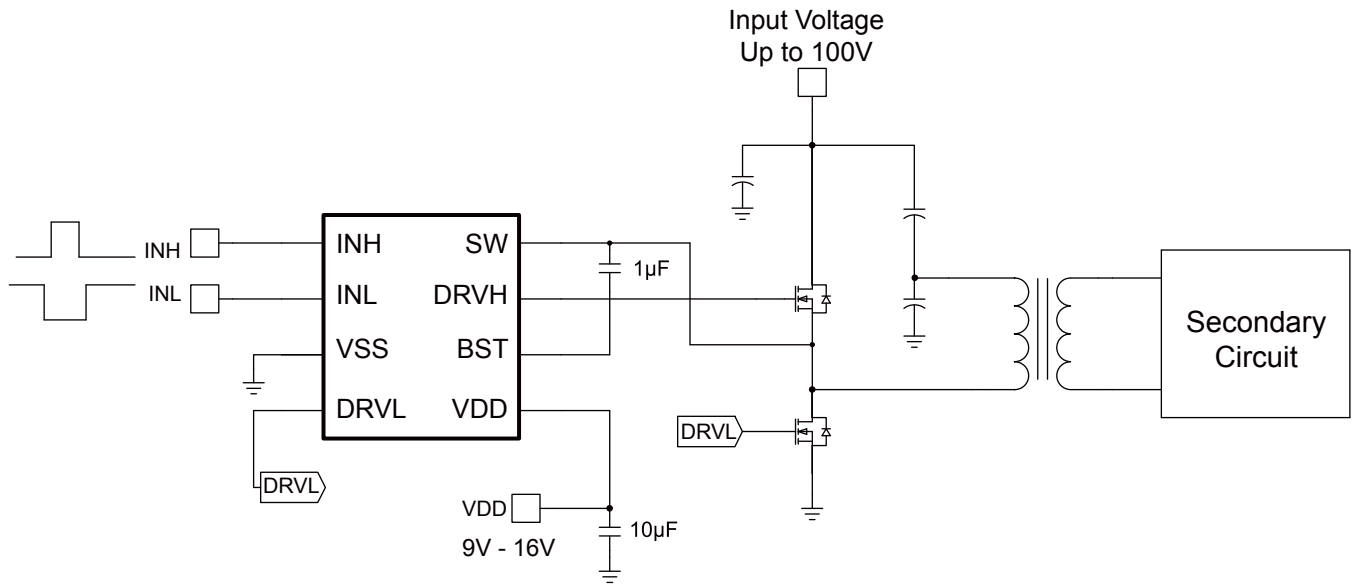


Figure 4: Half Bridge Converter

### Two-Switch Forward Converter

In two-switch forward converter topology, both MOSFETs are turned on and off simultaneously. The input signal (INH and INL) comes from a PWM controller that senses the output voltage (and output current during current-mode control).

The Schottky diodes clamp the reverse swing of the power transformer and must be rated for the input voltage. The input voltage can go up to 100V.

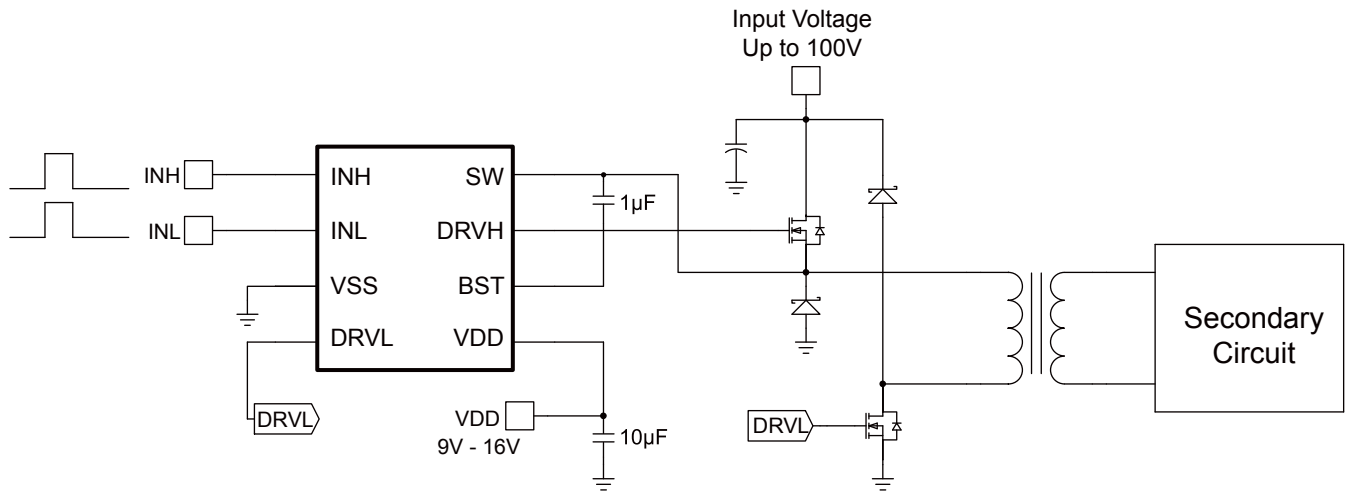
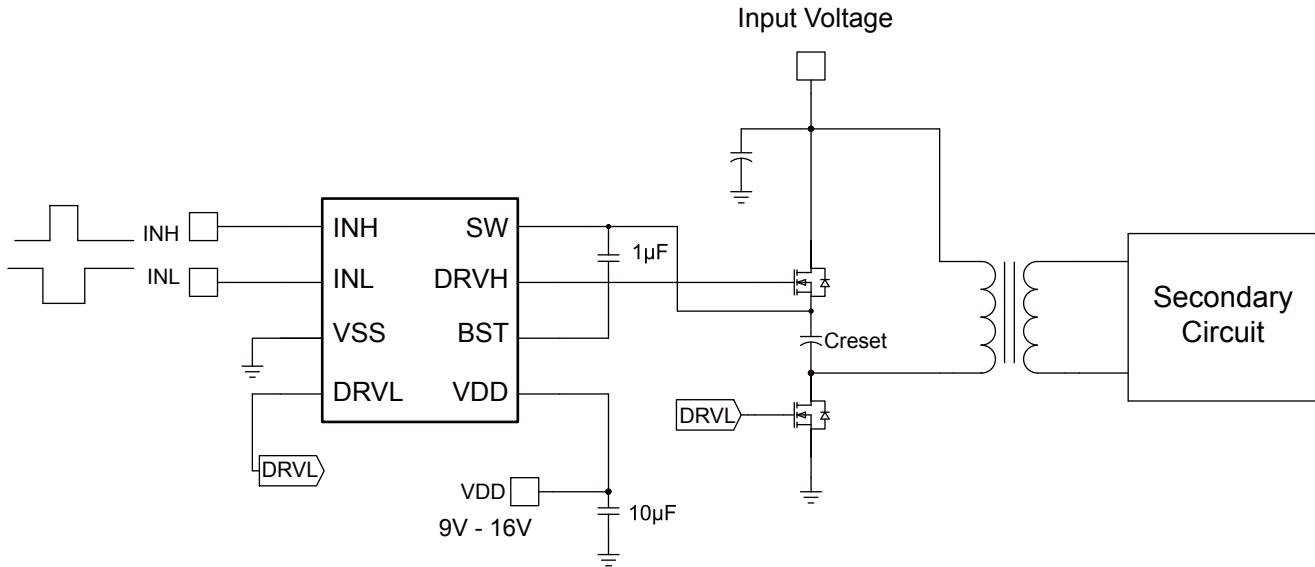


Figure 5: Two-Switch Forward Converter

**Active-Clamp Forward Converter**

In active-clamp forward converter topology, the MP1924 drives the MOSFETs with alternating signals. The high-side MOSFET, in conjunction with  $C_{reset}$ , is used to reset the power transformer in a lossless manner.

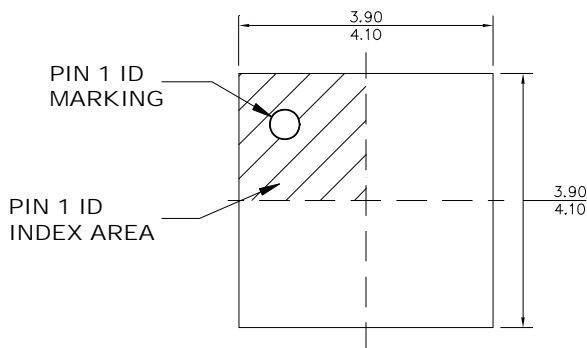
This topology lends itself well to run at duty cycles exceeding 50%. The device may not be able to run at 100V under this topology.



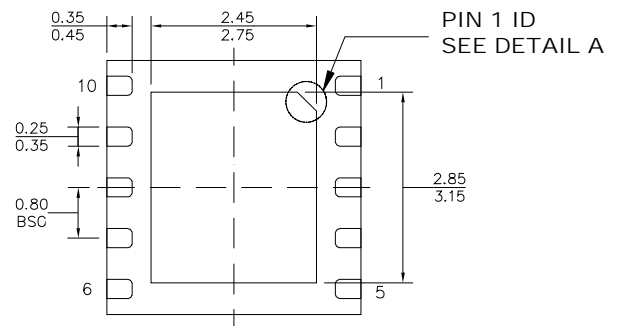
**Figure 6 Active-Clamp Forward Converter**

# PACKAGE INFORMATION

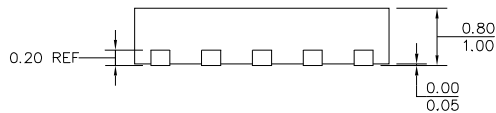
## QFN-10 (4mm×4mm)



TOP VIEW

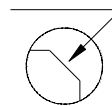


BOTTOM VIEW

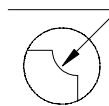


SIDE VIEW

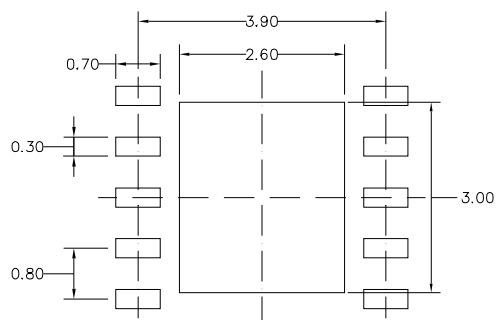
PIN 1 ID OPTION A  
0.30x45° TYP.



PIN 1 ID OPTION B  
R0.25 TYP.



DETAIL A

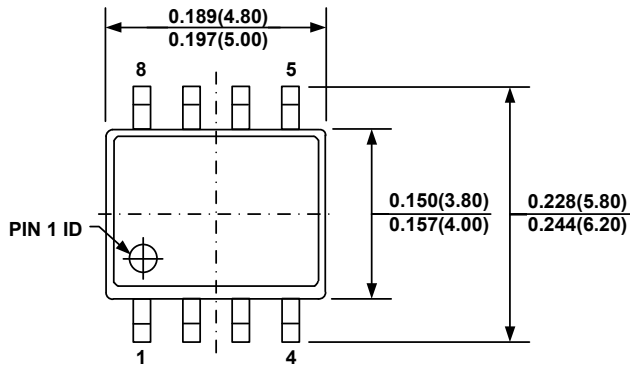


RECOMMENDED LAND PATTERN

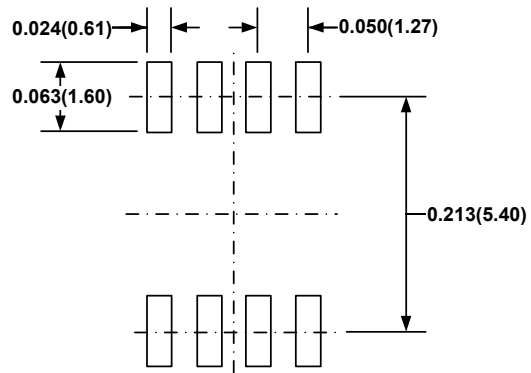
### NOTE:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
- 3) LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
- 4) JEDEC REFERENCE IS MO-220.
- 5) DRAWING IS NOT TO SCALE.

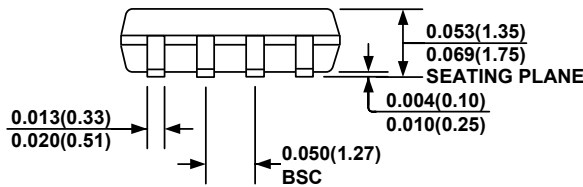
SOIC-8



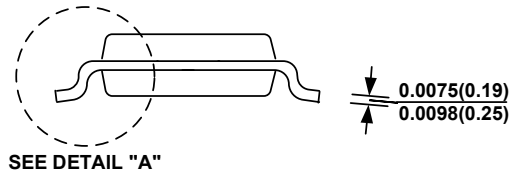
TOP VIEW



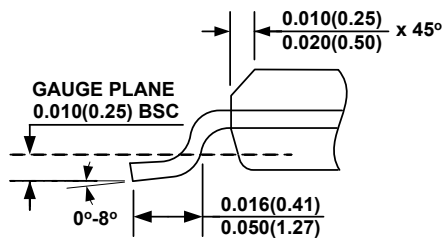
RECOMMENDED LAND PATTERN



FRONT VIEW



SIDE VIEW



DETAIL "A"

**NOTE:**

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

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